### **DISCRETE SEMICONDUCTORS**

# DATA SHEET

PMBFJ108; PMBFJ109; PMBFJ110 N-channel junction FETs

Product specification
File under Discrete Semiconductors, SC07

**April 1995** 





### N-channel junction FETs

PMBFJ108; PMBFJ109; PMBFJ110

### **FEATURES**

- · High-speed switching
- Interchangeability of drain and source connections
- Low R<sub>DSon</sub> at zero gate voltage ( < 8 Ω for PMBFJ108).</li>

### **DESCRIPTION**

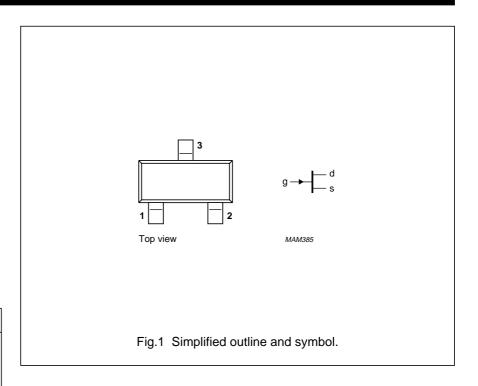
Symmetrical N-channel junction FETs in a SOT23 envelope. Intended for use in applications such as analog switches, choppers and commutators and in audio amplifiers.

### **PINNING - SOT23**

PIN	DESCRIPTION		
1	drain		
2	source		
3	gate		

### Note

1. Drain and source are interchangeable.



### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	drain-source voltage		_	±25	V
$V_{GSO}$	gate-source voltage		_	-25	V
$V_{GDO}$	drain-drain voltage		_	-25	<b>V</b>
I <sub>G</sub>	forward gate current (DC)			50	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25°C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		-65	150	°C
Tj	operating junction temperature		_	150	°C

April 1995 2

Philips Semiconductors Product specification

## N-channel junction FETs

PMBFJ108; PMBFJ109; PMBFJ110

### THERMAL RESISTANCE

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th j-a</sub>	from junction to ambient (note 1)	500	K/W

### **Notes**

1. Mounted on an FR-4 printboard.

### STATIC CHARACTERISTICS

 $T_j = 25$  °C.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
-I <sub>GSS</sub>	reverse gate current	-V <sub>GS</sub> = 15 V V <sub>DS</sub> = 0	_	3	nA
I <sub>DSX</sub>	drain-source cut-off current	$V_{GS} = -10 \text{ V}$ $V_{DS} = 5 \text{ V}$	_	3	nA
I <sub>DSS</sub>	drain current	$V_{GS} = 0$			
	PMBFJ108	$V_{DS} = 15 \text{ V}$	80	_	mA
	PMBFJ109		40	_	
	PMBFJ110		10	_	
-V <sub>(BR)GSS</sub>	gate-source breakdown voltage	$-I_G = 1 \mu A$ $V_{DS} = 0$	_	25	V
-V <sub>GS(off)</sub>	gate-source cut-off voltage	$I_D = 1 \mu A$			
	PMBFJ108	$V_{DS} = 5 V$	3	10	V
	PMBFJ109		2	6	
	PMBFJ110		0.5	4	
R <sub>DS(on)</sub>	drain-source on-resistance	V <sub>GS</sub> = 0 V			
	PMBFJ108	$V_{DS} = 0.1 \text{ V}$	_	8	Ω
	PMBFJ109		_	12	
	PMBFJ110		_	18	

April 1995 3

Philips Semiconductors Product specification

### N-channel junction FETs

PMBFJ108; PMBFJ110

#### **DYNAMIC CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
C <sub>is</sub>	input capacitance	V <sub>DS</sub> = 0 -V <sub>GS</sub> = 10 V f = 1 MHz	15	30	pF
C <sub>is</sub>	input capacitance	$V_{DS} = 0$ $-V_{GS} = 0$ $f = 1 \text{ MHz}$ $T_{amb} = 25 \text{ °C}$	50	85	pF
C <sub>rs</sub>	feedback capacitance	V <sub>DS</sub> = 0 -V <sub>GS</sub> = 10 V f = 1 MHz	8	15	pF
Switching times	Switching times (see Fig.2)				
t <sub>d</sub>	delay time	note 1	2	_	ns
t <sub>on</sub>	turn-on time	note 1	4	_	ns
t <sub>s</sub>	storage time	note 1	4		ns
t <sub>off</sub>	turn-off time	note 1	6		ns

### **Notes**

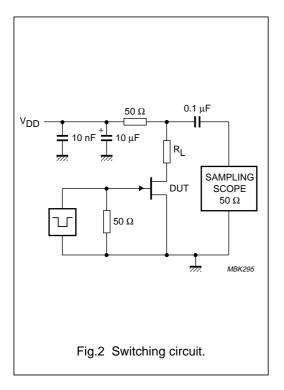
1. Test conditions for switching times are as follows:

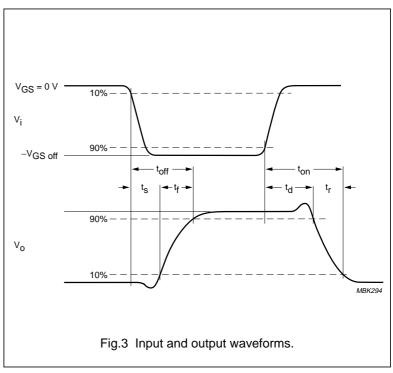
 $V_{DD}$  = 1.5 V,  $V_{GS}$  = 0 to  $-V_{GS(off)}$  (all types);

 $-V_{GS(off)} = 12 \text{ V}, R_L = 100 \Omega \text{ (PMBFJ108)};$ 

 $-V_{GS(off)} = 7 \text{ V}, R_L = 100 \Omega \text{ (PMBFJ109)};$ 

 $-V_{GS(off)} = 5 \text{ V}, R_L = 100 \Omega \text{ (PMBFJ110)}.$ 





April 1995 4

Philips Semiconductors Product specification

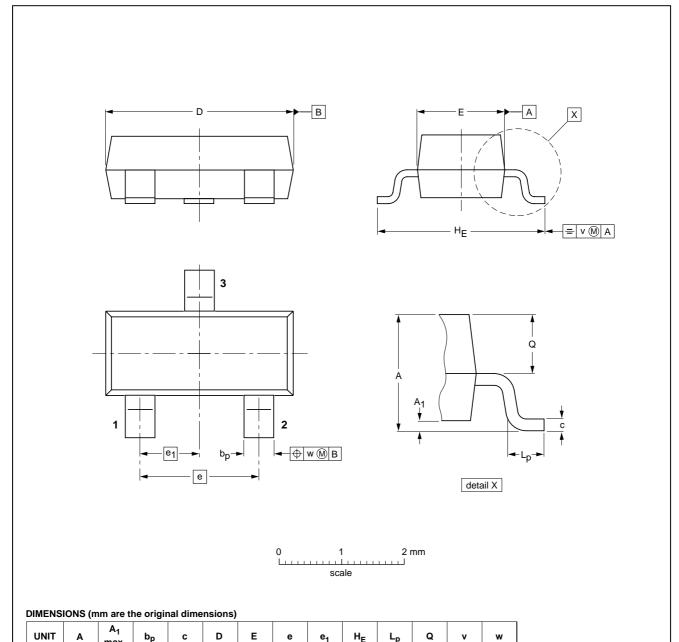
## N-channel junction FETs

PMBFJ108; PMBFJ109; PMBFJ110

### **PACKAGE OUTLINE**

Plastic surface mounted package; 3 leads

SOT23



OUTLINE		REFERENCES		REFERENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT23						97-02-28	

1.9

 $H_{\mathsf{E}}$ 

2.5 2.1

 $L_{p}$ 

0.45

0.15

0.55 0.45

0.1

April 1995 5

bp

0.48 0.38

3.0 2.8

0.15

0.09

max.

0.1

1.1

mm

Product specification Philips Semiconductors

### N-channel junction FETs

PMBFJ108; PMBFJ109; PMBFJ110

#### **DEFINITIONS**

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Short-form specification	The data in this specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

**April 1995** 6